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HOT AIR SOLDER LEVELER

HASL NTO-1824LF

The Hot air solder leveler model NTO-1824 is built to meet the current performance criteria. High quality, simple operation and maintenance at minimum costs is giving this machine access to both small and large volume production facilities.

Special attention has been given to those typical critical areas resulting in this high quality and reliability machine, in order to secure the superior quality of Hot Air Solder Leveled Printed Circuit Boards in the following years. The soldering machines of New technology Overman is specially designed for the new requirements in PCB manufacturing.

Easy accessibility to clean the solder, maintenance friendly, simple operating, easy acces to the removeable solder pump. Available as PLC (Siemens TIA Portal programed) controlled with Touch panel.



TECHNICAL DATA:

Туре :	NTO-1824LF
Application :	Tin / Lead solder and Lead free solder
Construction :	All stainless Steel, except for standard components of other materials.
Dimensions (LxWxH) :	1900 x 1000 x 1900mm - 74,8 x 39,4" x 74,8" inches
Weight (Kg – Lbs) :	± 700 Kg. – 1543 Lbs
Max. Panel size (mm – inch) :	460 x 530mm - 18" x 21"
	(Optional : 460 x 610mm - 18" x 24" when using Top guides)
Max./Min Panel thickness	0,8 - 6mm / 0,03 x 0,24 inch
(mm – inch) :	
Capacity	Up to 200 panels/hour.
Power	3 x 380 VAC 50 Hz., 29kW 3 x 220 VAC 60 Hz., 29kW

All specifications are subject to change without prior notice



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PLC, electrical, pneumatic Siemens Touch panel, all production parameters in PLC , pre-selectable
Siemens Touch nanel all production parameters in PLC pre-selectable
Siemens rouen panel, an production parameters in rice, pre selectasie
programs, easy to operate.
6-8 bar, 50 m ³ /hour, 300-500 ltr. air accumulator recommended.
87 - 116 PSI, 30 cfm, 68 -113 gallons air accumulator recommended.
(1¼" input line)
approx. 1800-2000 m ³ /hour - 1060-1180 cfm
Lead free : ± 270/300 Kg 600/660 lbs
Lead/Tin : ±305/340 Kg 675/750 lbs
(lead/Tin or Tin, Electronic Quality recommended)
Solder pot complete made of inox 316 material.
Overflowing inner-pot with re-circulation pump. Spent flux overflow
drain system. Solder pot complete insulated
Stainless steel re-circulation pump with two variable speed.
Strip-heaters, PID temperature controlled by PLC, low and high alarm
and over temperature safety lock.
Strip-heaters, PID temperature controlled by PLC, low and high alarm
and over temperature safety lock.
Stainless steel or Titanium, release / lock mounting system; Self-cleaning;
Adjustable orifice, distance, off-set and angle.
Front panel pilot controlled pressure regulation with gauges.
Foot pedal controlled pneumatic systems.
Frame supported and guided clamp system, with adjustable
rail mounted fixture. Stainless steel or Titanium clamping system.
OPTIONAL : 45° CLAMPING SYSTEM
Linear unit with drive motor controlled by PLC
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(variable speed controlled),
(variable speed controlled), 1 or 2 cycles programmable,
(variable speed controlled),
(variable speed controlled), 1 or 2 cycles programmable,

